

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3403760

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the NAME OF THE FIRST INVENTOR, "SUENG ZEON HAN" TO READ AS --SEUNG ZEON HAN-- previously recorded on Reel 035496 Frame 0307. Assignor(s) hereby confirms the CORRECT NAME OF THE FIRST INVENTOR IS SEUNG ZEON HAN.
CONVEYING PARTY DATA	
Name	Execution Date
SEUNG ZEON HAN	03/31/2015
HONG RAE JOH	03/31/2015
JEE HYUK AHN	03/31/2015
KWANG HO KIM	03/31/2015
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Internal Address:	GEUMJEONG-GU
City:	BUSAN
State/Country:	KOREA, REPUBLIC OF
Postal Code:	609-735
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14694969
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	039406.000005
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NAME OF SUBMITTER:	HENRY B. WARD, III
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SIGNATURE:	/hbw/
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DATE SIGNED:	06/18/2015
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Total Attachments: 5

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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT3324551

SUBMISSION TYPE:	NEW ASSIGNMENT	COPY
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
SUENG ZEON HAN		03/31/2015
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Internal Address:	GEUMJEONG-GU	
City:	BUSAN	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	609-735	
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PATENT

REEL: 035977 FRAME: 0750

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ASSIGNMENT - WORLDWIDE

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each undersigned inventor has sold and assigned, and by these presents hereby sells and assigns, unto KOREA INSTITUTE OF MACHINERY & MATERIALS ("Assignee"), (Jang-dong), 156 Gajeonbuk-ro, Yuseong-gu, Daejeon 305-343, Republic of Korea and Global Frontier Hybrid Interface Materials("Assignee"), (Jangjeon-dong) 2, Busandaehak-ro 63beon-gil, Geumjeong-gu, Busan 609-735, Republic of Korea its successors and assigns, the entire right, title and interest, so far as concerns the United States and the Territories and Possessions thereof and all foreign countries in and to the invention in

Ti-included oxide dispersion strengthened copper alloy and method for manufacturing dispersed copper

as set forth in the following United States Patent Application ("Invention")

- ☒ executed concurrently herewith
☐ executed on _____ (Date)
☐ Application No. _____; filed _____

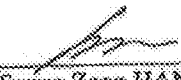
(the "Application") and in all divisional, renewal, substitute, continuation, nonprovisionals, continuation-in-parts, and Convention applications based in whole or in part upon said Invention or upon said Application (together with the Application, collectively referred to as the "Applications"), and any and all letters patent and reissues, reexaminations, reviews and extensions of said letters patent (collectively, referred to as "Letters Patent") granted for said Invention or upon said Applications and every priority right that is or may be predicated upon or arise from said Invention, said Applications, and said Letters Patent; said Assignee being hereby authorized to file patent applications in any or all countries on any portion or all said Invention in the name of the undersigned or in the name of said Assignee or otherwise as said Assignee may deem advisable, under the International Convention or otherwise; the Commissioner of Patents and Trademarks of the United States of America being hereby authorized to issue or transfer all said Letters Patent to said Assignee in accordance herewith; this assignment being under covenant, not only that full power to make the same is had by the undersigned, but also that such assigned right is not encumbered by any grant, license, or other right theretofore given, and that the undersigned will do all acts reasonably serving to ensure that the said Invention, Applications and Letters Patent shall be held and enjoyed by said Assignee as fully and entirely as the same could have been held and enjoyed by the undersigned if this assignment had not been made, and particularly to execute and deliver to said Assignee all lawful documents including petitions, specifications, oaths, assignments, invention disclaimers, declarations, and lawful affidavits in form and substance which may be requested by said Assignee, to furnish said Assignee with all facts relating to said Invention or the history thereof and any and all documents, photographs, models, samples or other physical exhibits which may embody said Invention, and to testify in any proceedings relating to said Invention, Applications, and/or Letters Patent.

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The undersigned hereby grant(s) an authorized representative of Assignee the power to insert in this Assignment any further identification that may be necessary or desirable to comply with the rules of the U.S. Patent and Trademark Office for recordation of this Assignment.

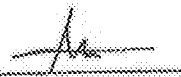
Date: March 31, 2015


Seung Zeon HAN

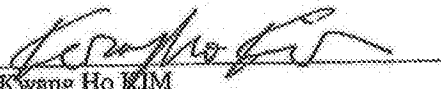
Date: March 31, 2015


Hong Rae JOH

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Jee Hyuk AHN

Date: March 31, 2015


Kwang Ho KIM